Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

Rev. 3 — 6 December 2012

Product data sheet

1. General description

The 74LVC374A is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock input (CP) and an outputs enable input (\overline{OE}) are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When pin \overline{OE} is LOW, the contents of the eight flip-flops is available at the outputs. When pin \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

The 74LVC374A is functionally identical to the 74LVC574A, but has a different pin arrangement.

2. Features and benefits

- 5 V tolerant inputs/outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- 8-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- **ESD** protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



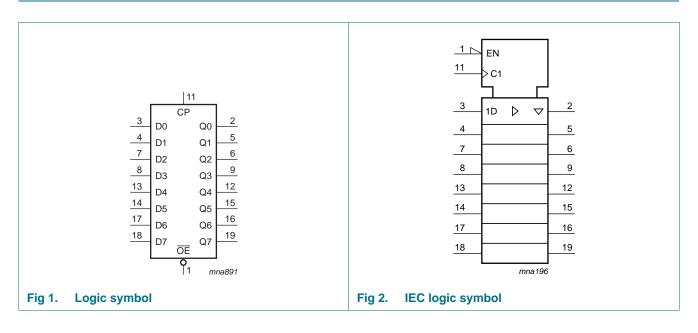
Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

3. Ordering information

Table 1.Ordering information

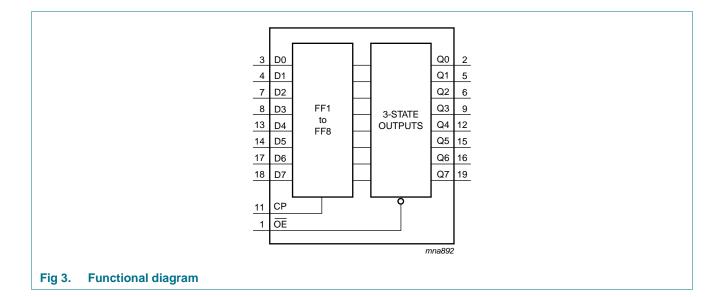
Type number	Package			
	Temperature range	Name	Description	Version
74LVC374AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC374ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC374APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC374ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1

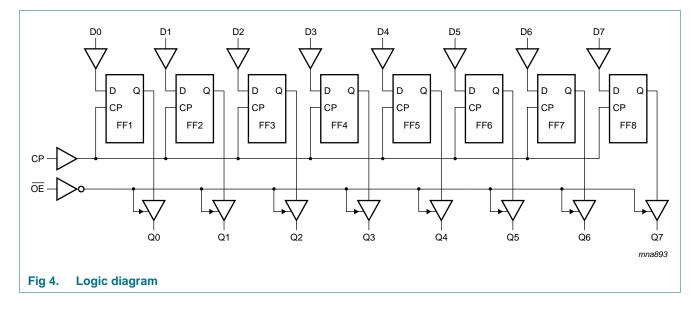
4. Functional diagram



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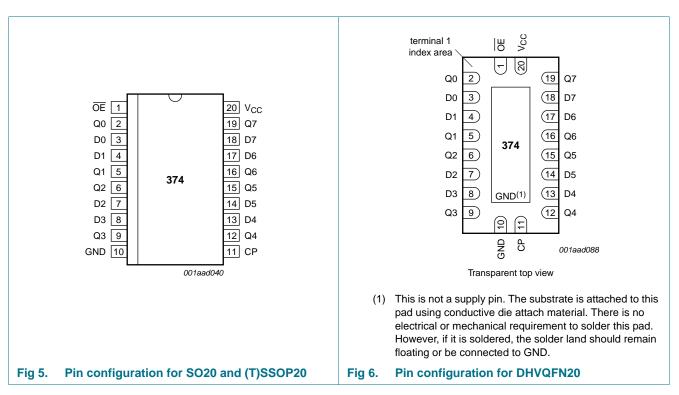




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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2. **Pin description** Symbol Pin Description OE output enable input (active LOW) 1 Q[0:7] 2, 5, 6, 9, 12, 15, 16, 19 3-state flip-flop output D[0:7] 3, 4, 7, 8, 13, 14, 17, 18 data input GND 10 ground (0 V) clock input (LOW-to-HIGH, edge-triggered) CP 11 20 V_{CC} supply voltage

Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

6. Functional description

Table 3.Function table^[1]

Operating mode	Input		Internal flip-flop	Output	
	OE	СР	Dn	_	Qn
Load and read register	L	\uparrow	I	L	L
	L	\uparrow	h	Н	Н
Load register and disable	Н	\uparrow	Ι	L	Z
outputs	Н	↑	h	Н	Z

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

 \uparrow = LOW-to-HIGH clock transition

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V		-50	-	mA
VI	input voltage		<u>[1]</u>	-0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	V_{O} > V_{CC} or V_{O} < 0 V		-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2]	-0.5	V _{CC} + 0.5	V
		output 3-state	[2]	-0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[3]	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
 For SSOP20 and TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
 For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating conditions							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
V _{CC}	supply voltage		1.65	-	3.6	V		
		functional	1.2	-	-	V		
VI	input voltage		0	-	5.5	V		
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V		
		output 3-state	0	-	5.5	V		
T _{amb}	ambient temperature	in free air	-40	-	+125	°C		
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V		
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V		

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40) °C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Мах	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
input voltage	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35\times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
V _{OH} HIGH-level	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \ to \ 3.6 \ V$	$V_{CC} - 0.$ 2	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I_{O} = 100 µA; V_{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		I_{O} = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V

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Symbol	Parameter	Conditions	–40 °C to +85 °C			-40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Max	Min	Max	
l _l	input leakage current	V_{CC} = 3.6 V; $V_{\rm I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; \\ V_{O} = 5.5 \text{ V or GND};$	-	±0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0$ V; V_{I} or $V_{O} = 5.5$ V	-	±0.1	±10	-	±20	μA
I _{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	10	-	40	μΑ
∆l _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} – 0.6 V; I _O = 0 A	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	4.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	C to +85 °C		–40 °C to +125 °C	
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 7	[2]						
	delay	V _{CC} = 1.2 V		-	16	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.2	7.4	16.3	2.2	18.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.9	8.4	1.5	9.7	ns
		$V_{CC} = 2.7 V$		1.5	3.5	8.0	1.5	10.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.3	7.0	1.5	9.0	ns
t _{en} en	enable time	OE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	6.6	16.7	1.5	19.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.7	9.3	1.5	10.8	ns
		$V_{CC} = 2.7 V$		1.5	3.8	8.5	1.5	11.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.0	7.5	1.5	9.5	ns
t _{dis}	disable time	OE to Qn; see Figure 8	[2]						
		$V_{CC} = 1.2 V$		-	8.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.3	4.0	10.1	2.3	11.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.2	5.7	1.0	6.7	ns
		V _{CC} = 2.7 V		1.5	3.1	6.5	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.9	6.0	1.5	7.5	ns

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Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Мах	
W	pulse width	clock HIGH or LOW; see Figure 7							
		V_{CC} = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.0	-	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.0	1.5	-	4.5	-	ns
t _{su}	set-up time	Dn to CP; see Figure 9							
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		4.0	-	-	4.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		3.0	-	-	3.0	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	0	-	2.0	-	ns
t _h hold ti	hold time	Dn to CP; see Figure 9							
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	0.6	-	1.5	-	ns
f _{max}	maximum	see Figure 7							
	frequency	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		100	-	-	64	-	MHz
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	-	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per flip-flop; $V_I = GND$ to V_{CC}	[4]						
	dissipation	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	11.6	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	13.6	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	15.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volt

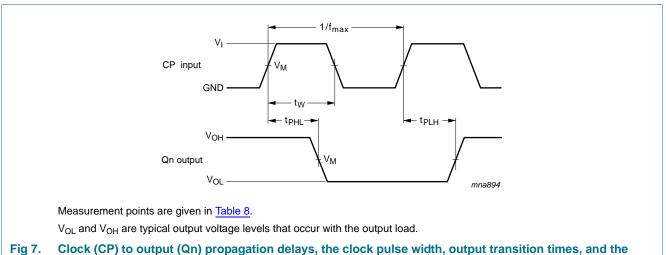
N = number of inputs switching $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs

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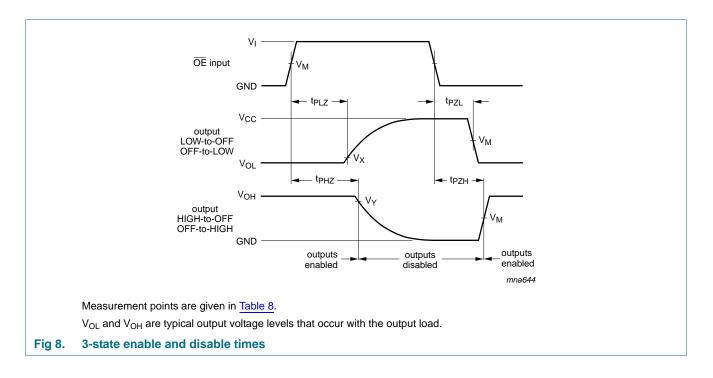
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11. Waveforms



maximum frequency



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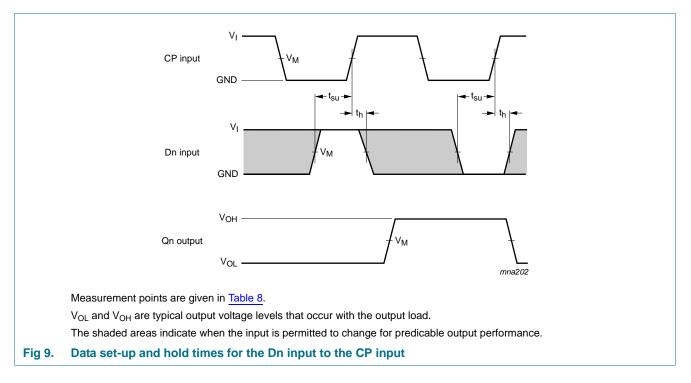
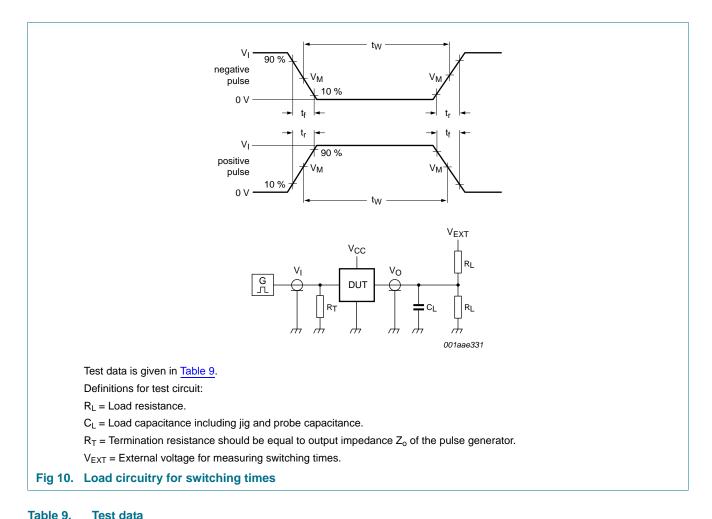


Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{cc}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			

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	-						
Supply voltage	Input		Load		V _{EXT}		
V _{cc}	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND

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12. Package outline

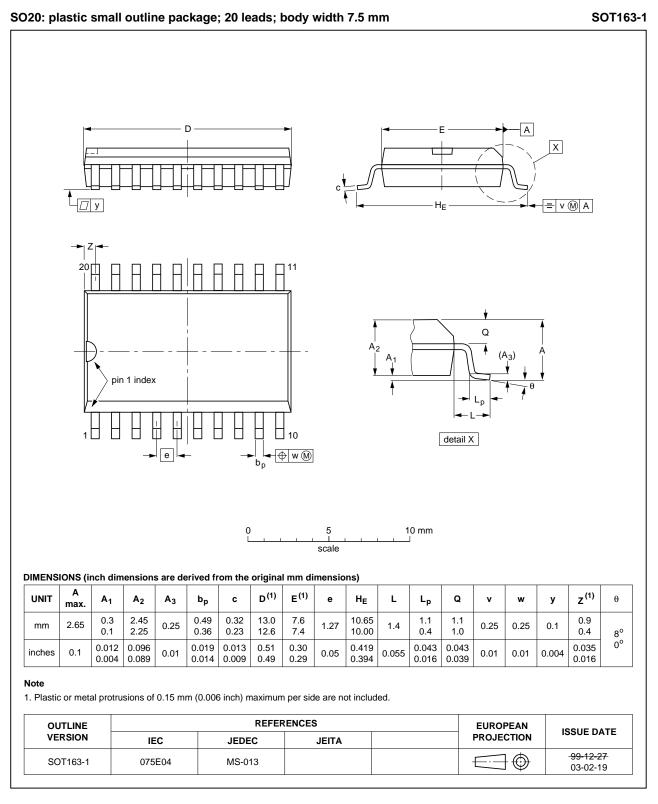


Fig 11. Package outline SOT163-1 (SO20)

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

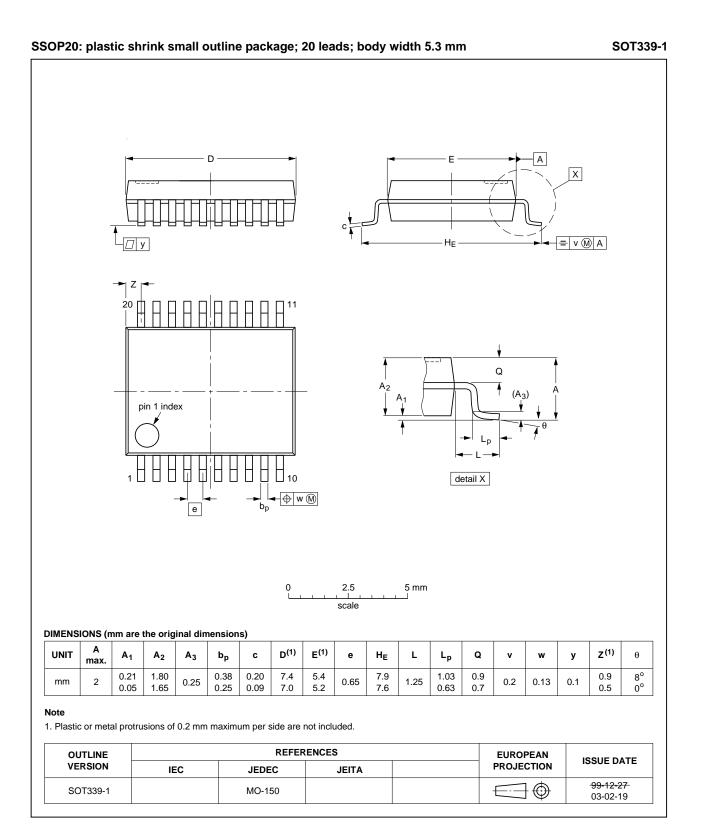


Fig 12. Package outline SOT339-1 (SSOP20)

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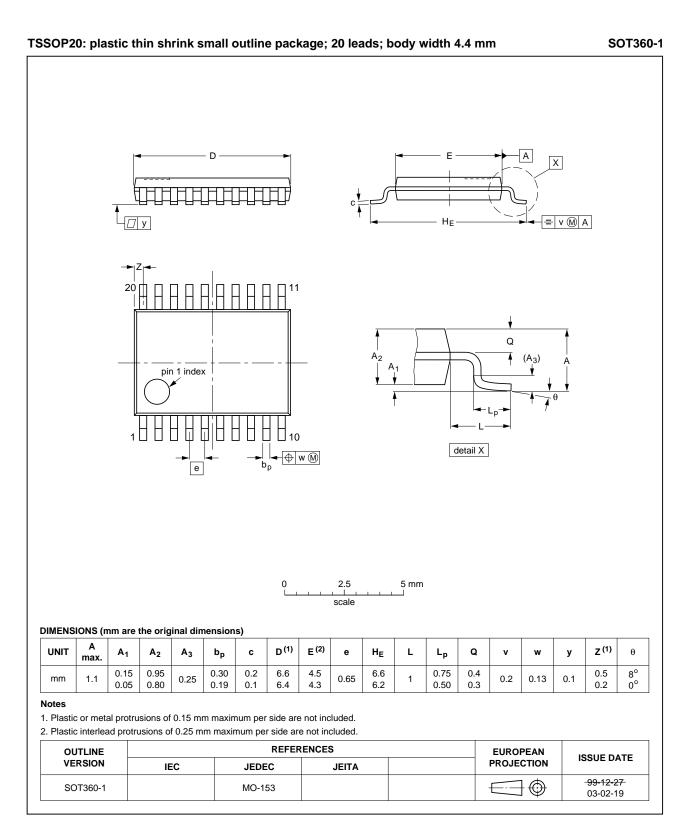
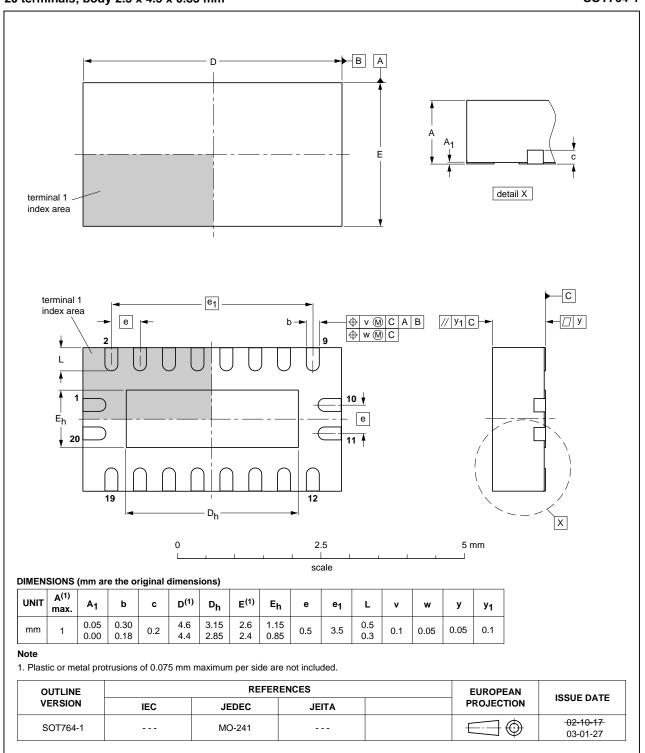


Fig 13. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 14. Package outline SOT764-1 (DHVQFN20)

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

story					
Release date	Data sheet status	Change notice	Supersedes		
20121206	Product data sheet	-	74LVC374A v.2		
Modifications: • The format of this data sheet has been redesigned to comply with the new identity guideling of NXP Semiconductors.					
 Legal texts have be 	een adapted to the new c	ompany name where app	propriate.		
• Table 4, Table 5, Table 5	able 6, <u>Table 7, Table 8</u> ar	nd <u>Table 9</u> : values added	for lower voltage ranges.		
20030514	Product specification	-	74LVC374A v.1		
19980729	Product specification	-	-		
	Release date 20121206 • The format of this of of NXP Semicondu • Legal texts have be • Table 4, Table 5, Table 20030514	Release date Data sheet status 20121206 Product data sheet • The format of this data sheet has been redered of NXP Semiconductors. • Legal texts have been adapted to the new contrast texts • Table 4, Table 5, Table 6, Table 7, Table 8 art 20030514	Release date Data sheet status Change notice 20121206 Product data sheet - • The format of this data sheet has been redesigned to comply with the of NXP Semiconductors. - • Legal texts have been adapted to the new company name where apprevalues added - • Table 4, Table 5, Table 6, Table 7, Table 8 and Table 9: values added - 20030514 Product specification -		

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

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